

General Description

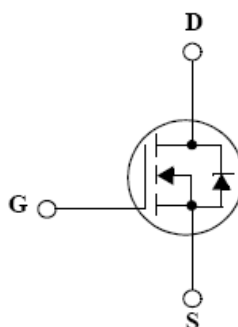
The MDP7N50 uses advanced Magnachip's MOSFET Technology, which provides low on-state resistance, high switching performance and excellent quality. MDP7N50 is suitable device for SMPS, HID and general purpose applications.

Features

- $V_{DS} = 500V$
- $I_D = 7.0A$ @ $V_{GS} = 10V$
- $R_{DS(ON)} < 0.9\Omega$ @ $V_{GS} = 10V$

Applications

- Power Supply
- HID
- Lighting



Absolute Maximum Ratings ($T_a = 25^\circ C$)

Characteristics		Symbol	Rating	Unit
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	± 30	V
Continuous Drain Current	$T_C = 25^\circ C$	I_D	7.0	A
	$T_C = 100^\circ C$		4.2	A
Pulsed Drain Current ⁽¹⁾		I_{DM}	28	A
Power Dissipation	$T_C = 25^\circ C$	P_D	114	W
	Derate above $25^\circ C$		0.91	W/ $^\circ C$
Peak Diode Recovery dv/dt ⁽³⁾		Dv/dt	4.5	V/ns
Single Pulse Avalanche Energy ⁽⁴⁾		E_{AS}	270	mJ
Junction and Storage Temperature Range		T_J, T_{stg}	-55~150	$^\circ C$

Thermal Characteristics

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Ambient ⁽¹⁾	$R_{\theta JA}$	62.5	$^\circ C/W$
Thermal Resistance, Junction-to-Case ⁽¹⁾	$R_{\theta JC}$	1.1	

Ordering Information

Part Number	Marking	Temp. Range	Package	Packing
MDP7N50	MDP7N50	-55~150°C	TO-220	Tube

Electrical Characteristics (Ta =25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D = 250\mu A, V_{GS} = 0V$	500	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	3.0	-	5.0	
Drain Cut-Off Current	I_{DSS}	$V_{DS} = 500V, V_{GS} = 0V$	-	-	1	μA
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 30V, V_{DS} = 0V$	-	-	100	nA
Drain-Source ON Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 3.5A$		0.76	0.9	Ω
Forward Transconductance	g_{fs}	$V_{DS} = 30V, I_D = 3.5A$	-	7	-	S
Dynamic Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 400V, I_D = 7.0A, V_{GS} = 10V^{(3)}$	-	17.5		nC
Gate-Source Charge	Q_{gs}		-	5		
Gate-Drain Charge	Q_{gd}		-	6.5		
Input Capacitance	C_{iss}	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$	-	740		pF
Reverse Transfer Capacitance	C_{rss}		-	3.7		
Output Capacitance	C_{oss}		-	95.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DS} = 250V, I_D = 7.0A, R_G = 25\Omega^{(3)}$	-	16.8		ns
Rise Time	t_r		-	29.8		
Turn-Off Delay Time	$t_{d(off)}$		-	36.4		
Fall Time	t_f		-	23.6		
Drain-Source Body Diode Characteristics						
Maximum Continuous Drain to Source Diode Forward Current	I_S		-	7.0	-	A
Source-Drain Diode Forward Voltage	V_{SD}	$I_S = 7.0A, V_{GS} = 0V$	-		1.4	V
Body Diode Reverse Recovery Time	t_{rr}	$I_F = 7.0A, di/dt = 100A/\mu s^{(3)}$	-	260		ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	1.7		μC

Note :

1. Pulse width is based on $R_{\theta JC}$ & $R_{\theta JA}$ and the maximum allowed junction temperature of 150°C.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$, pulse width limited by junction temperature $T_J(MAX)=150^\circ C$.
3. $I_{SD} \leq 7.0A$, $di/dt \leq 200A/\mu s$, $V_{DD}=50V$, $R_G=25\Omega$, Starting $T_J=25^\circ C$
4. $L=10mH$, $I_{AS}=7.0A$, $V_{DD}=50V$, $R_G=25\Omega$, Starting $T_J=25^\circ C$

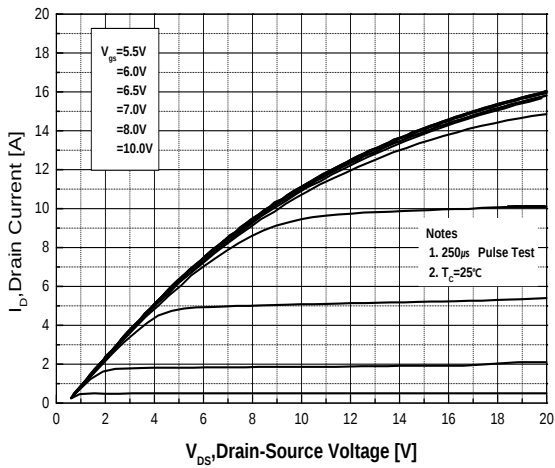


Fig.1 On-Region Characteristics

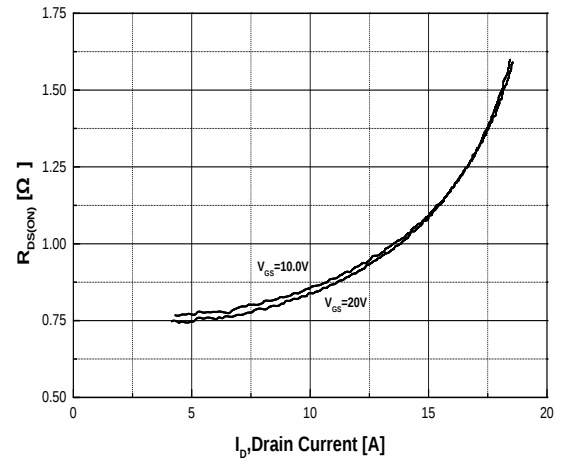


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

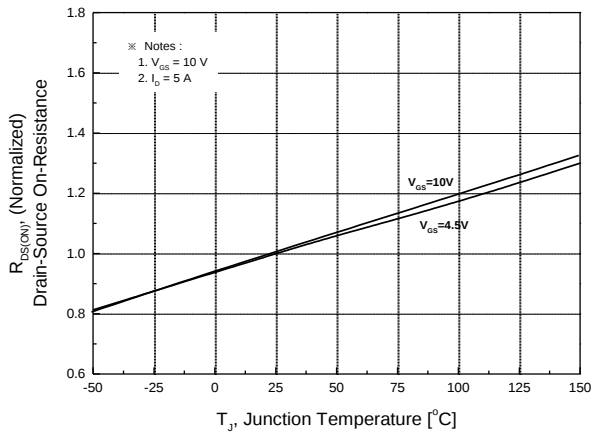


Fig.3 On-Resistance Variation with Temperature

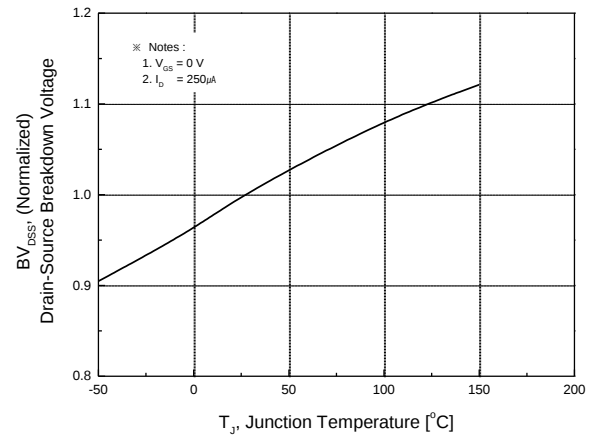


Fig.4 Breakdown Voltage Variation vs. Temperature

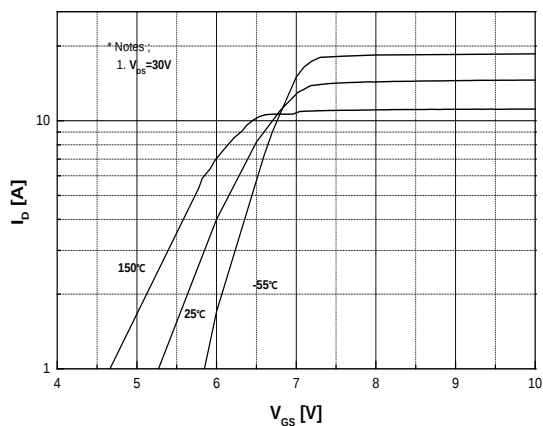


Fig.5 Transfer Characteristics

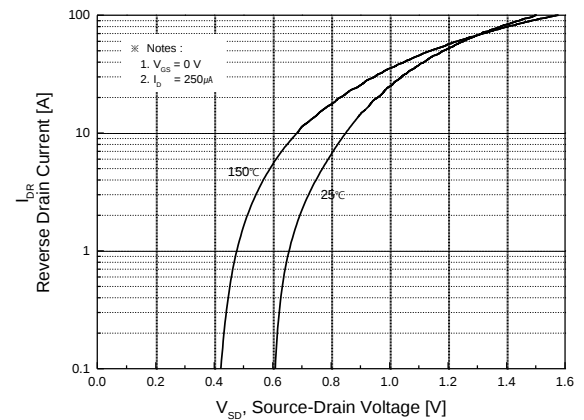


Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

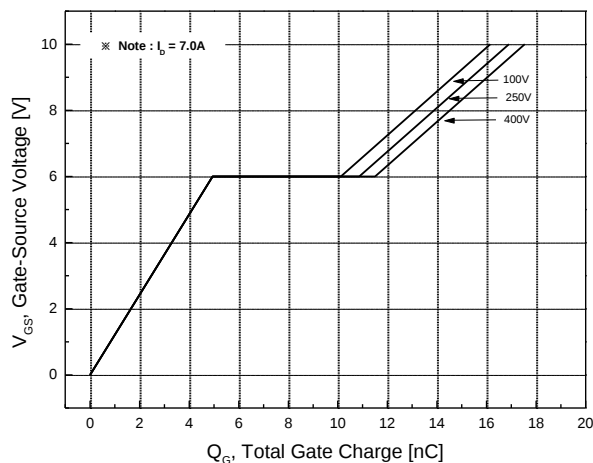


Fig.7 Gate Charge Characteristics

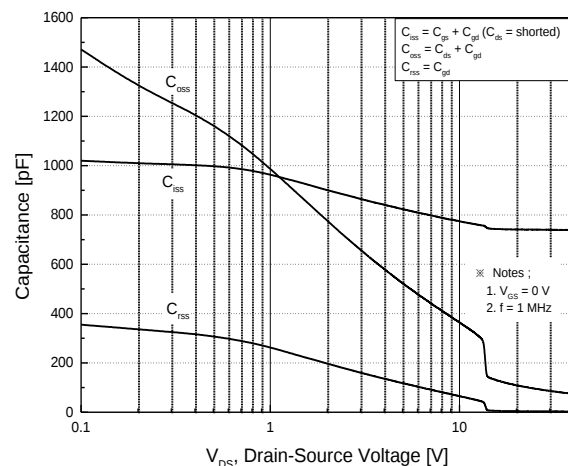


Fig.8 Capacitance Characteristics

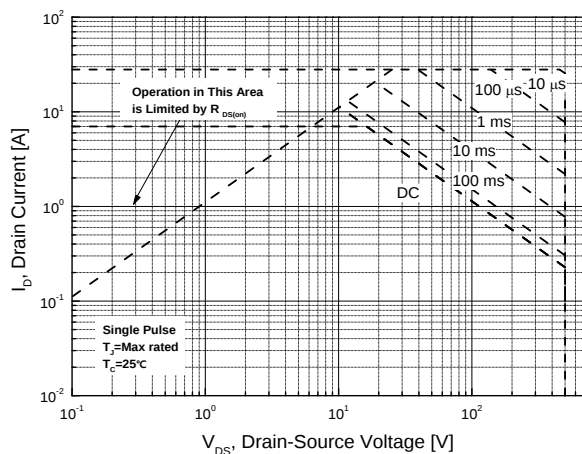


Fig.9 Maximum Safe Operating Area

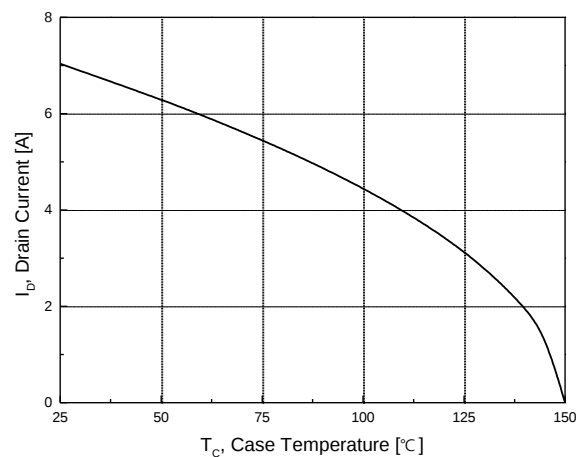


Fig.10 Maximum Drain Current vs. Case Temperature

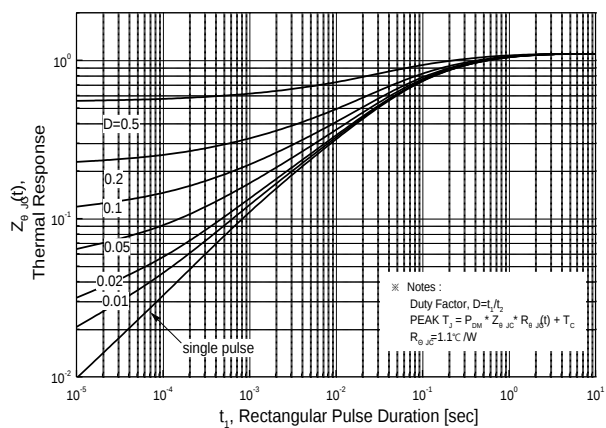


Fig.11 Transient Thermal Response Curve

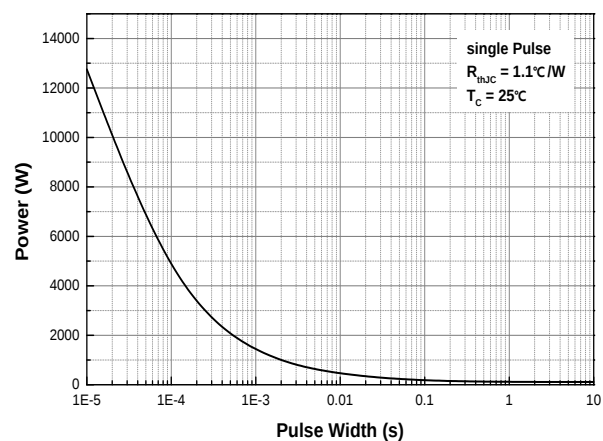


Fig.12 Single Pulse Maximum Power Dissipation

DISCLAIMER:

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